Specification of Thermoelectric Module TETS1-24160-T200-TF00-AC-Al0

Description

The 241 couples,40 mm \times 40 mm size single module is made of selected high performance ingot and fabricated by our unique "soft" processes to achieve superior cooling/heating performance. The module is able to run over one hundred thousand thermal cycles in 70 $^{\circ}$ C temperature change range with less 3% degrading. It is good for the need of frequently cooling down and heating up to 180 $^{\circ}$ C applications. All the dices and metallic parts are coated with a layer of thin film for anti-corrosion and oxidation in high temperature that ensure the module can work in high temperature for long life. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

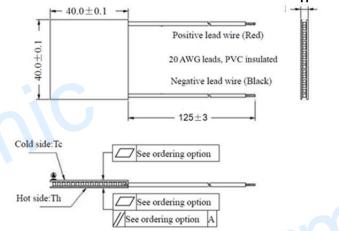
Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th(°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U _{max} (Voltage)	30.3	32.7	Voltage applied to the module at DT _{max}	
I _{max(} amps)	6.0	6.0	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	114.0	124.6	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance(ohms)	3.85	4.15	The module resistance is tested under AC	
Tolerance (%)	±10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

A. Solder:

T200: CuSn (M.P.= 227 ℃)

B. Sealant:

SS: Silicone sealant

C. Ceramics:

AlO: Alumina (Al_2O_3 , white 96%)

D. Ceramics Surface Options:

Blank ceramics (not metalized)

E. Pellet Surface Options:

AC: Anti-oxidation Coating

Flatness/ Parallelism Option

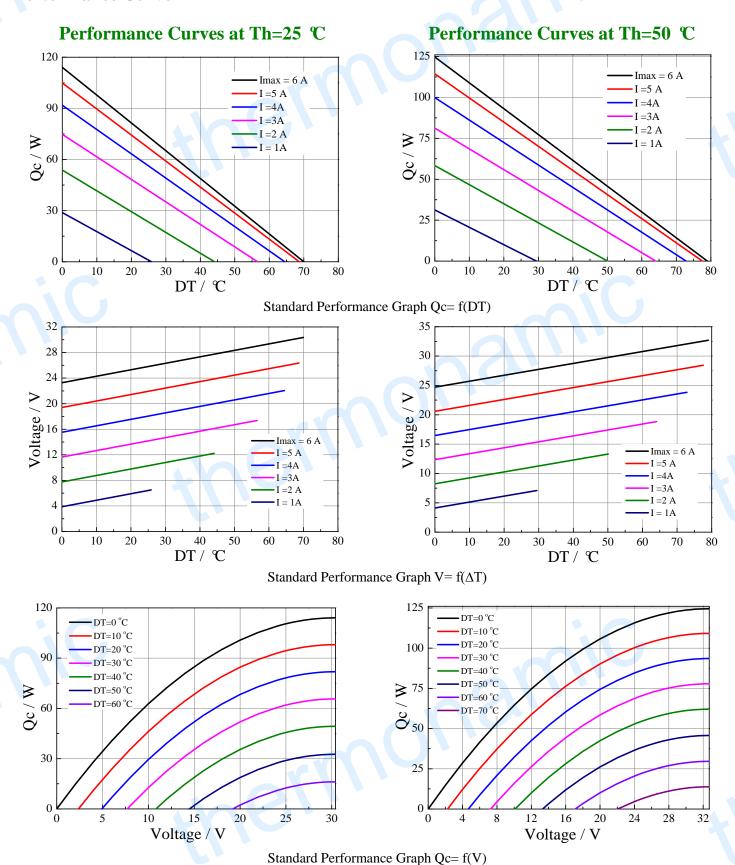
Suffix	Thickness	Flatness/ Parallelism	Lead wire length(mm)
	(mm)	(mm)	Standard/Optional length
TF	0:3.1±0.1	0:0.08/0.08	125±3/Specify

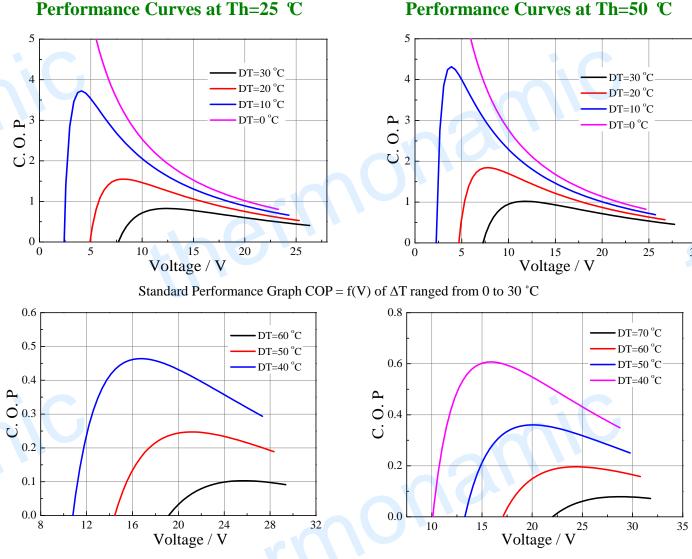
Operation Cautions

- Cold side of the module sticked on the object being cooled
- Hot side of the module mounted on a heat radiator
- Work under DC

- \bullet Operation below I_{max} or V_{max}
- Operation or storage module below 100 °C

Performance Curve



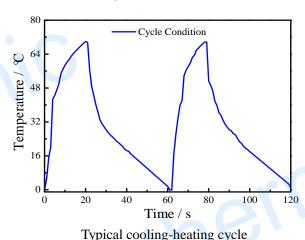


Standard Performance Graph COP = f(V) of ΔT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

A typical 127 couples module is fabricated by the unique "soft" process and has demonstrated that it only has 2.5% degrading after 300,000 thermal cycling. The below graphic shows that in beginning 120,000 cycles, it degrade about 2.5%, and then go on stable with very tiny degrading in further 180,000 thermal cycles. It is derived out that the modules can go over million thermal cycles.

TEC Thermal Cycle Lifetime Test On TETC1-12706



TEC Module cycled at Tc = 0 C and Th = 70 C

TEC reference Module without cycled

AC Resistance change

3 50 0 0 0 0 0 8 16 24 32

Cycle Number / 10⁴

The Chart for AC Resistance and AC Resistance Changes

vs Cycle Number